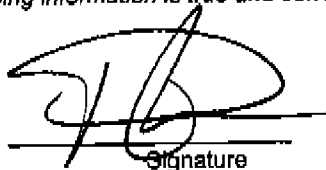


Attorney Docket No. 018865-010210US

Form PTO-1595 (Rev. 10-02) OMB No. 0651-0027 (exp. 6/30/2005)	RECORDATION FORM COVER SHEET PATENTS ONLY	U.S. Department of Commerce U.S. Patent and Trademark Office
To the Honorable Commissioner of Patents and Trademarks. Please record the attached original documents or copy thereof		
1. Name of conveying party(ies): Rajeev Joshi Additional name(s) of conveying party(ies) attached? <input checked="" type="checkbox"/> Yes <input type="checkbox"/> No	2. Name and address of receiving party(ies) Name: <u>Fairchild Semiconductor Corporation</u> Internal Address: _____ Street Address: <u>82 Running Hill Road MS 35-4E</u> City: <u>South Portland</u> State: <u>ME</u> ZIP: <u>04106</u> Additional name(s) and address(es) attached? <input type="checkbox"/> Yes <input checked="" type="checkbox"/> No	
3. Nature of conveyance: <input checked="" type="checkbox"/> Assignment <input type="checkbox"/> Merger <input type="checkbox"/> Security Agreement <input type="checkbox"/> Change of Name <input type="checkbox"/> Other: _____	Execution Date: <u>March 7, 2003 and March 11, 2003</u>	
4. Application number(s) or patent number(s): If this document is being filed together with a new application, the execution date of the application is: _____ A. Patent Application No(s): <u>10/386,621</u> B. Patent No(s): _____ Additional numbers attached? <input type="checkbox"/> Yes <input type="checkbox"/> No		
5. Name and address of party to whom correspondence concerning document should be mailed: Name: <u>Patrick R. Jewik</u> <u>TOWNSEND AND TOWNSEND AND CREW LLP</u> <u>Two Embarcadero Center, 8th Floor</u> <u>San Francisco, California 94111-3834</u> <u>(415) 576-0200</u>	6. Total number of applications and patents involved <u>1</u> 7. Total fee (37 CFR 3.41): <u>\$40.00</u> <input type="checkbox"/> Enclosed <input checked="" type="checkbox"/> Authorized to be charged to deposit account 8. Deposit account number: <u>20-1430</u> (Attach duplicate copy of this page if paying by deposit account)	
DO NOT USE THIS SPACE		
9. Statement and signature. <i>To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.</i> <div style="display: flex; justify-content: space-between; align-items: flex-end;"> <div style="text-align: center;"> <u>Patrick R. Jewik</u> Name of Person Signing Atty. Reg. No. 40,456 </div> <div style="text-align: center;">  Signature </div> <div style="text-align: center;"> <u>1/8/04</u> Date </div> </div>		

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Form PTO-1595
Recordation Form Cover Sheet
Patents Only
Page 2

1. Additional name(s) of conveying party(ies):
(Continued from Page 1)

Consuelo Tangpuz
Erwin Victor R. Cruz

2. Additional name(s) and address(es) of receiving party(ies):
(Continued from Page 1)

3. Additional application number(s) or patent number(s):
(Continued from Page 1)

A. Patent Application No.(s)

B. Patent No.(s)

11439431 v1

Attorney Docket No.: 018865-010210US
Client Reference No.: 17732.60790

ASSIGNMENT OF PATENT APPLICATION

JOINT

WHEREAS, Rajeev Joshi of 10168 Colby Ave., Cupertino, CA 95014; Consuelo Tangpuz of 464 Maximo Patalinhug Jr. Avenue, Lapu-Lapu City, Cebu, Philippines 6015; Erwin Victor R. Cruz, of #85 Mabini Street, Koronadal City, Philippines 9506 hereinafter referred to as "Assignors," are the inventors of the invention described and set forth in the below-identified application for United States Letters Patent:

Title of Invention: WAFER-LEVEL COATED COPPER STUD BUMPS

Date(s) of execution of Declaration:

Filing Date: *March 11, 2003*

Application No.: *10/386,621*; and

WHEREAS, Fairchild Semiconductor Corporation, a corporation of the state of Delaware, located at 82 Running Hill Road, MS 35-4E, South Portland, ME, 04106, hereinafter referred to as "ASSIGNEE," is desirous of acquiring an interest in the invention and application and in any U.S. Letters Patent and Registrations which may be granted on the same;

For good and valuable consideration, receipt of which is hereby acknowledged by Assignors, Assignors have assigned, and by these presents do assign to Assignee all right, title and interest in and to the invention and application and to all foreign counterparts (including patent, utility model and industrial designs), and in and to any Letters Patent and Registrations which may hereafter be granted on the same in the United States and all countries throughout the world, and to claim the priority from the application as provided by the Paris Convention. The right, title and interest is to be held and enjoyed by Assignee and Assignee's successors and assigns as fully and exclusively as it would have been held and enjoyed by Assignors had this Assignment not been made, for the full term of any Letters Patent and Registrations which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

Assignors further agree that they will, without charge to Assignee, but at Assignee's expense, (a) cooperate with Assignee in the prosecution of U.S. Patent applications and foreign counterparts on the invention and any improvements, (b) execute, verify, acknowledge and deliver all such further papers, including patent applications and instruments of transfer, and (c) perform such other acts as Assignee lawfully may request to obtain or maintain Letters Patent and Registrations for the invention and improvements in any and all countries, and to vest title thereto in Assignee, or Assignee's successors and assigns.

Assignors hereby authorize and request Townsend and Townsend and Crew LLP, Two Embarcadero Center, 8th Floor, San Francisco, CA 94111-3834, to insert herein above the application number and filing date of said application when known.

Assignment
Attorney Docket No.: 018865-010210US
Page 2

IN TESTIMONY WHEREOF, Assignors have signed their names on the dates indicated.

Dated: March 7, 2003

R. Joshi

Rajeev Joshi

WITNESSED BY:

Name: _____

Address: _____

Date: _____

Dated: _____

Consuelo Tangpuz

WITNESSED BY:

Name: _____

Address: _____

Date: _____

Dated: _____

Erwin Victor R. Cruz

WITNESSED BY:

Name: _____

Address: _____

Date: _____

SF 1439102 v1

Attorney Docket No.: 018865-010210US
Client Reference No.: 17732.60790

ASSIGNMENT OF PATENT APPLICATION

JOINT

WHEREAS, Rajeev Joshi of 10168 Colby Ave., Cupertino, CA 95014; Consuelo Tangpaz of 464 Maximo Patalinhug Jr. Avenue, Lapu-Lapu City, Cebu, Philippines 6015; Erwin Victor R. Cruz, of #85 Mabini Street, Koronadal City, Philippines 9506 hereinafter referred to as "Assignors," are the inventors of the invention described and set forth in the below-identified application for United States Letters Patent:

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For good and valuable consideration, receipt of which is hereby acknowledged by Assignors, Assignors have assigned, and by these presents do assign to Assignee all right, title and interest in and to the invention and application and to all foreign counterparts (including patent, utility model and industrial designs), and in and to any Letters Patent and Registrations which may hereafter be granted on the same in the United States and all countries throughout the world, and to claim the priority from the application as provided by the Paris Convention. The right, title and interest is to be held and enjoyed by Assignee and Assignee's successors and assigns as fully and exclusively as it would have been held and enjoyed by Assignors had this Assignment not been made, for the full term of any Letters Patent and Registrations which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

Assignors further agree that they will, without charge to Assignee, but at Assignee's expense, (a) cooperate with Assignee in the prosecution of U.S. Patent applications and foreign counterparts on the invention and any improvements, (b) execute, verify, acknowledge and deliver all such further papers, including patent applications and instruments of transfer, and (c) perform such other acts as Assignee lawfully may request to obtain or maintain Letters Patent and Registrations for the invention and improvements in any and all countries, and to vest title thereto in Assignee, or Assignee's successors and assigns.

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Assignment
Attorney Docket No.: 018865-010210US
Page 2

IN TESTIMONY WHEREOF, Assignors have signed their names on the dates indicated.

Dated: _____

Rajeev Joshi

WITNESSED BY:

Name: CONSUELO N. TANGPUIZ

Address: 444 MAXIMO PATALINGHUG AVE, PAJO, LAPULAPU CITY

Date: March 11, 2003

Dated: March 11, 2003

Consuelo Tangpui

WITNESSED BY:

Name: ERWIN VICTOR R. CRUZ

Address: 485 MABINI STREET, KODNADAL CITY

Date: MARCH 11, 2003

Dated: MARCH 11, 2003

Erwin Victor R. Cruz

WITNESSED BY:

Name: _____

Address: _____

Date: _____

SF 1439102 v1